

08-08-2002



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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

William H. Connor and Brandon E. Taylor

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Date 1) July 23, 2002 2) July 23, 2002

2. Name and address of receiving party(ies):

Sun Microsystems, Inc.
901 San Antonio Road, Palo Alto, California, 94303

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: July 25, 2002

A. Patent Application No.(s):

B. Patent No.(s):

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

DAVID W. VICTOR, ESQ.
KONRAD RAYNES VICTOR & MANN LLP
315 S. Beverly Drive, Suite 210
Beverly Hills, CA 90212

6. Total number of applications and patents involved: [1]

7. Total fee (37 CFR 3.41).....\$ 40

☒ Enclosed

☐ Authorized to be charged to deposit account

8. Deposit account number: 50-0585

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David W. Victor

Name of Person Signing

Signature

July 25, 2002

Date

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Docket: P7294
0045.0034ASSIGNMENT

Whereas, we

INVENTOR
AND CITY

(1) Brandon E. Taylor

of Longmont
and State of Colorado
of Boulder
and State of Colorado

(2) William H. Connor

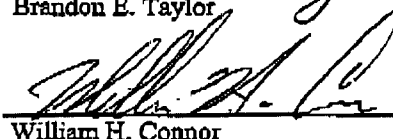
have invented certain improvement in

TITLE METHOD, SYSTEM, AND PROGRAM FOR MAKING OBJECTS AVAILABLE FOR ACCESS TO A CLIENT
OVER A NETWORKDATES THAT
INVENTORS
SIGNED THE
DECLARATIONand executed, respectively, a United States patent application therefore on
(1) _____, 2002 and (2) _____, 2002

Whereas, SUN MICROSYSTEMS, INC., a corporation of Delaware, having a place of business at 901 San Antonio Road, Palo Alto, California, 94303, (hereinafter called SUN), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefore;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign, and transfer to SUN, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to SUN, its successors and assigns; and I hereby agree that SUN may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by SUN.

Signed and sealed

CITY
DATE(1) at Boulder, CO
on July 23rd, 2002,
Brandon E. TaylorSIGNATURE
INVENTORCITY
DATE(2) at Boulder, CO
on July 22nd, 2002,
William H. ConnorSIGNATURE
INVENTOR